



NXP Hyperfast Enhanced Efficiency Diode in LCD TV SMPS

BYC8-600P & BYC8X-600P

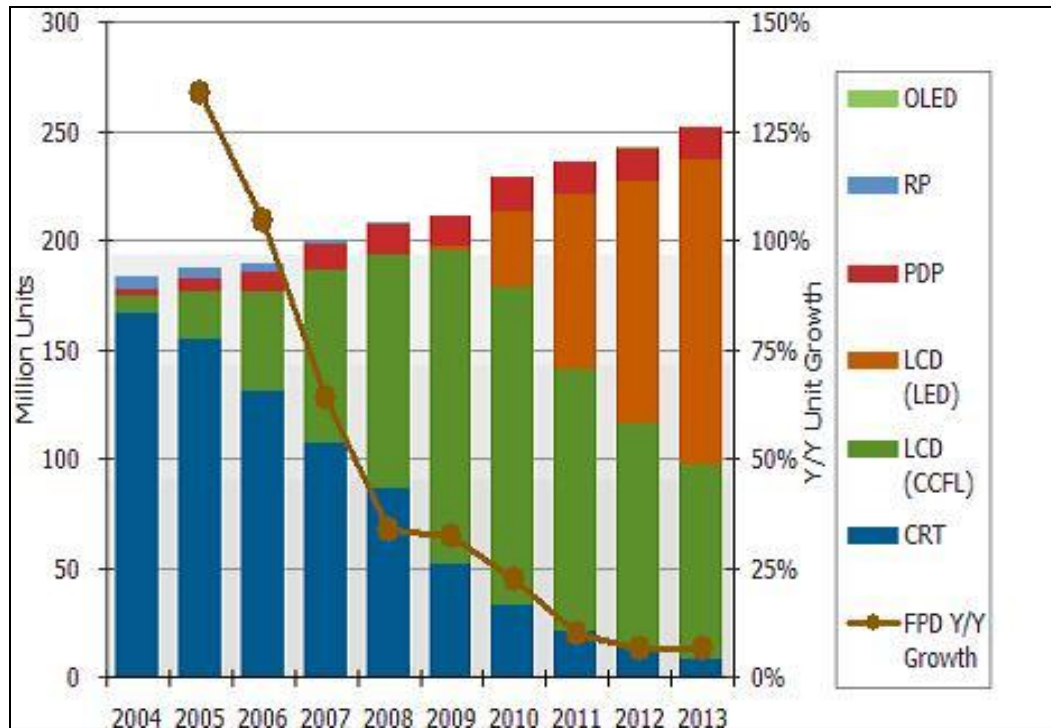


LCD/LED TV Power Adapter

TV Power Market Demands

How power diodes affect efficiency in PFC circuits

Global TV Shipment and Forecast



Source: Display Search

LCD TV(CCFL Backlight) began replacing traditional CRT TVs from 2007. Since 2010, LCD TV (LED Backlight) shipments have grown very fast and by the end of 2012 .Its market share is expected to exceed LCD TV(CCFL Backlight) volume. Continued growth for LCD TV with LED backlight technologies is expected.

LCD TV Power Market Demands

Energy Star

Version 5: Effective on May 01 / 2012



Viewable Screen Area A: square inches	Power on_max (Watts) A: square inches	Power on_max (Watts) A: square centimeters
$A < 275.0$	$P_{\max} = 0.130 \cdot A + 5$	$P_{\max} = 0.020 \cdot A + 5$
$275.0 \leq A \leq 1068.0$	$P_{\max} = 0.084 \cdot A + 18$	$P_{\max} = 0.013 \cdot A + 18$
$A > 1068.0$	108	108

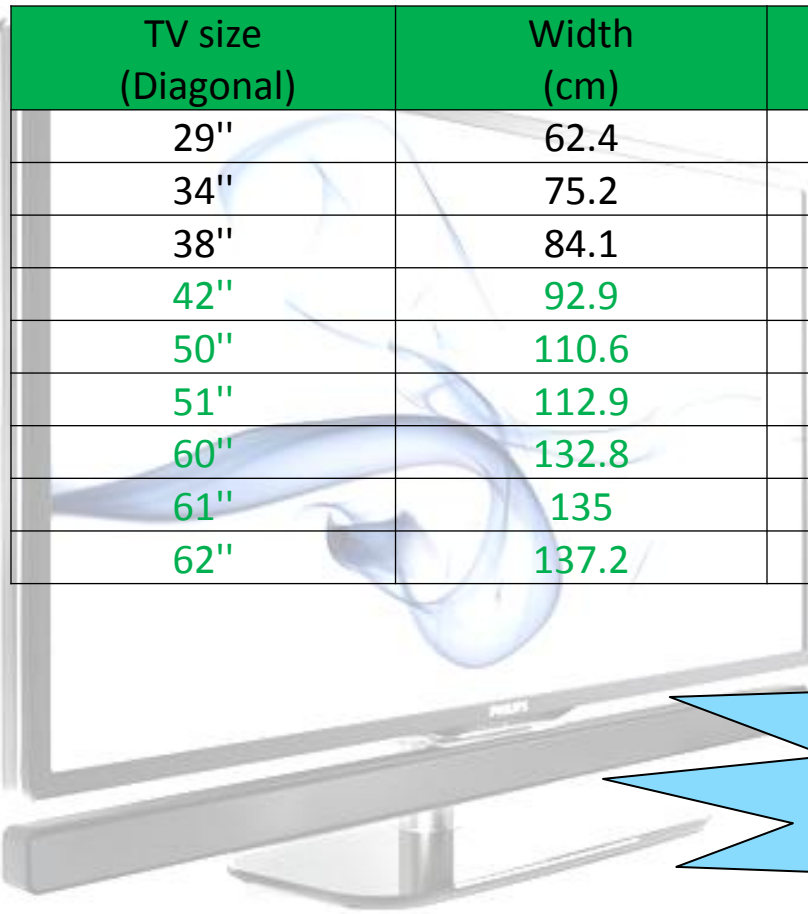
EU Energy Efficiency

EC642/2009: Effective on April 01 / 2012



Television type	Power on_max (Watts) A: expressed in dm^2
Television sets	$16 + A \cdot 34579$
Television monitors	$12 + A \cdot 34579$

Energy Star V 5.0 for TV

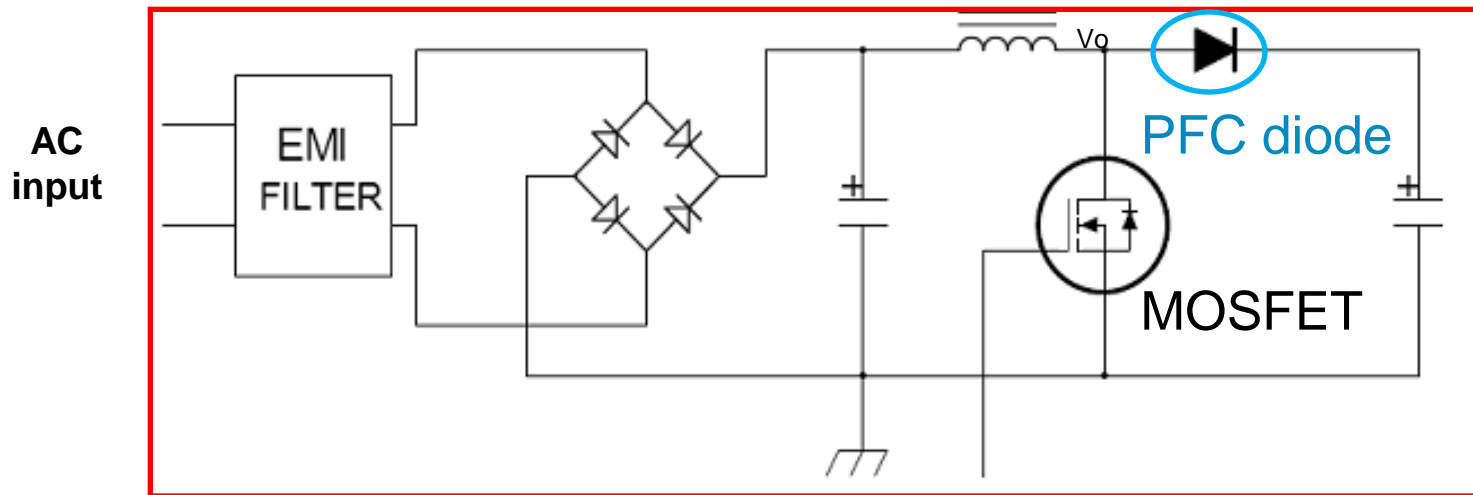


TV size (Diagonal)	Width (cm)	Height (cm)	Area Size (cm ²)	Power on_max (W)
29"	62.4	36.1	2300	47.9
34"	75.2	42.3	3200	59.6
38"	84.1	47.3	4000	70
42"	92.9	52.3	4900	81.7
50"	110.6	62.2	6900	107.7
51"	112.9	63.5	7200	108
60"	132.8	74.7	9900	108
61"	135	75.9	10300	108
62"	137.2	77.2	10600	108

Any TV size bigger
than 40" needs a
PFC circuit

PFC circuits need optimized PFC diodes!

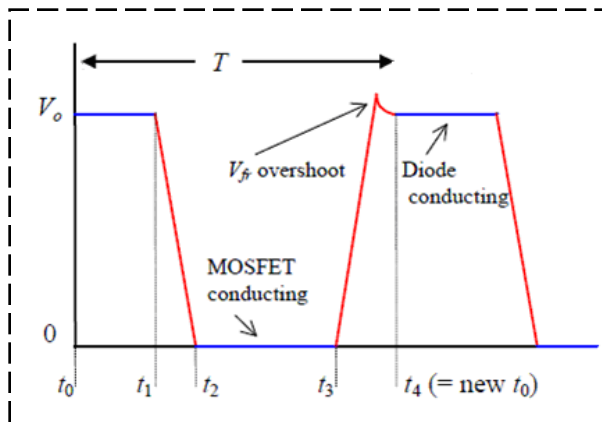
PFC Circuit in LCD TV SMPS



Conventional PFC topology.

PFC diode selection is concerned about diode parameters which affect power dissipation in both the PFC diode and the MOSFET.

Power Losses in a PFC circuit



How do power losses in PFC circuits relate to PFC diode parameters? (see following slides)

Contributors to Power losses in PFC circuits	Significance	Why	Parameter
MOSFET on-state losses	Minimized	due to MOSFET's "on resistance"	MOSFET, $R_{ds(on)}$
MOSFET switching losses	Minimized	due to MOSFET's internal capacitances	MOSFET, C_{gd} , C_{gs} , C_{ds}
MOSFET turn-on losses	Very high	induced by reverse recovery of PFC diode	Diode reverse recovery time, T_{rr} Diode reverse recovered charge, Q_R Diode peak reverse recovery current, I_{RM}
Diode forward losses	Very small	forward conduction losses	Diode forward voltage, V_F
Diode switching losses	Very small	reverse recovery losses	Diode reverse recovery time, T_{rr} Diode forward recovery voltage, V_{FR}

NXP Hyperfast Enhanced Efficiency Diode

Quick Reference Data
Application Evaluation

BYC8-600P & BYC8X-600P

Overview

Description

Hyperfast Enhanced Efficiency Diode - Platinum (Pt) doped 600V Power diode
Continuous Current Mode (CCM) Rectifier Diode for High Efficiency SMPS applications

Key features

Hyperfast reverse recovery time - $T_{rr} \text{ (typ)} \leq 12\text{ns}$ @ $I_F = 1\text{A}$, $V_R = 200\text{V}$, $di_F/dt = 200\text{A}/\mu\text{s}$;
Low forward voltage - $V_F \text{ (max)} < 1.9\text{V}$ @ $I_F = 8\text{A}$, $T_j = 125^\circ \text{C}$;
Low reverse leakage current - $I_R \leq 200\mu\text{A}$ @ $V_R = 600\text{V}$, $T_j = 125^\circ \text{C}$;
Available in TO-220AC, TO-220F("full pack") and DPAK packages;

Benefits

Significantly reduces the power dissipation in MOSFET at SMPS primary side
Reduces the size of required heatsink
Low leakage for improved reliability
Planar passivated for voltage ruggedness and reliability
Industry standard packages

Key Parameters (1)

Forward Voltage (V_F) and Reverse Recovery Time (T_{rr})

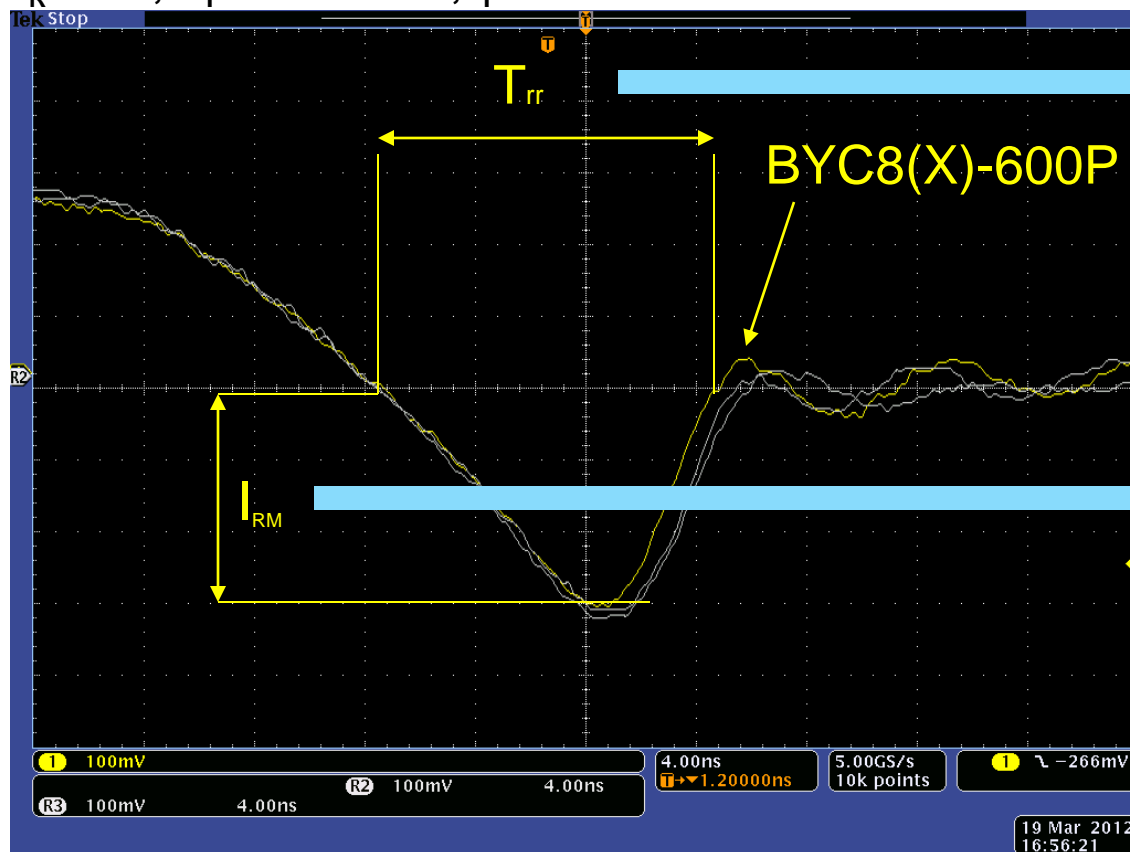
Vendor	V_F @ $I_F = 8A$; 125degC	T_{rr} @ $I_F = 1A$, $V_R = 200V$, $di_F/dt = 200 A/\mu s$	I_{RM} @ $I_F = 1A$, $V_R = 200V$, $di_F/dt = 200 A/\mu s$
NXP	$\leq 1.9V$	10ns	3.8A
Competitor 1	$\leq 1.9V$	12ns	4.4A
Competitor 2	2.1V	13ns	3.8A

For PFC: BYC8-600P & BYC8X-600P have better specifications

Key Parameters (2)

Reverse Recovery Time (T_{rr}) waveform

$V_R = 30V$, $di_F/dt = 200A/us$, $I_F = 1A$

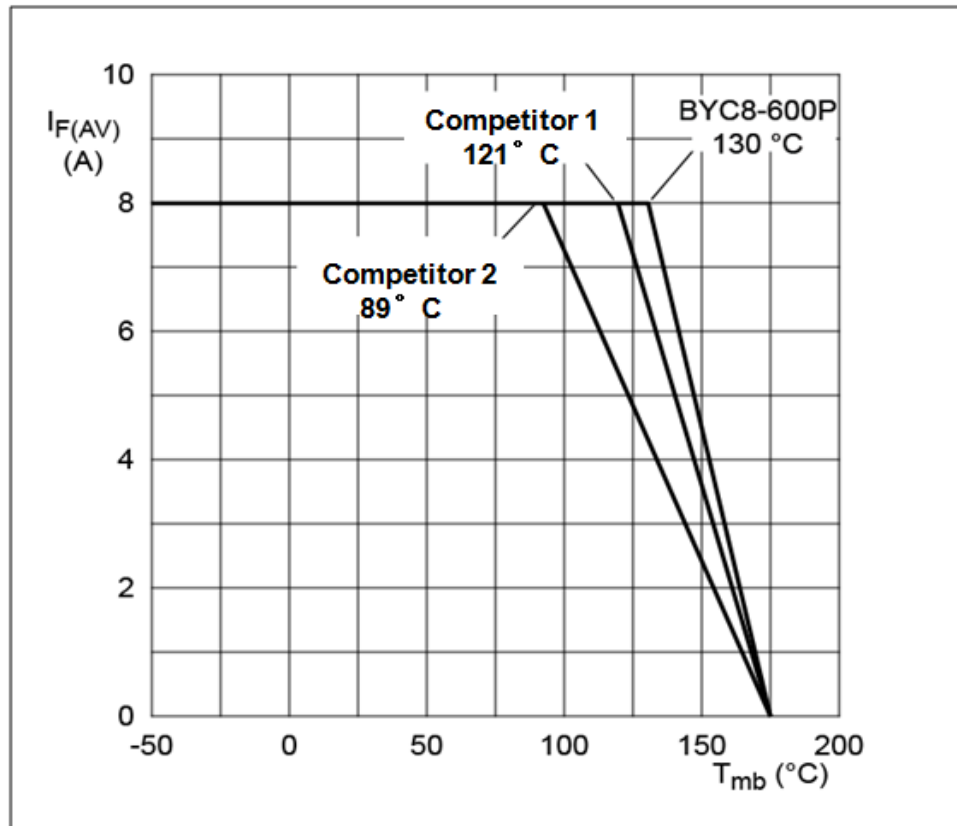


The faster the T_{rr}
the lower the power
dissipation in MOSFET

Competitive I_{RM}

Key Parameters (3)

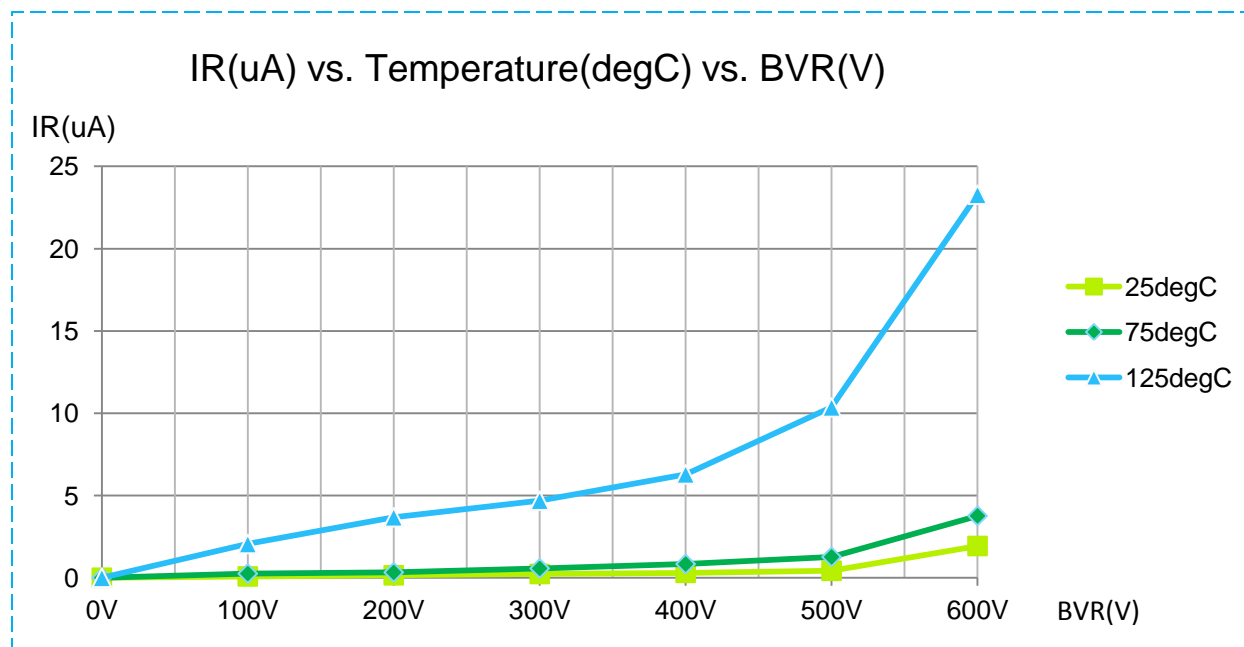
Forward Current Deration Curve vs. Temperature



According to the I_F deration curve, BYC8P-600 outperforms the other competitors.

Key Parameters (4)

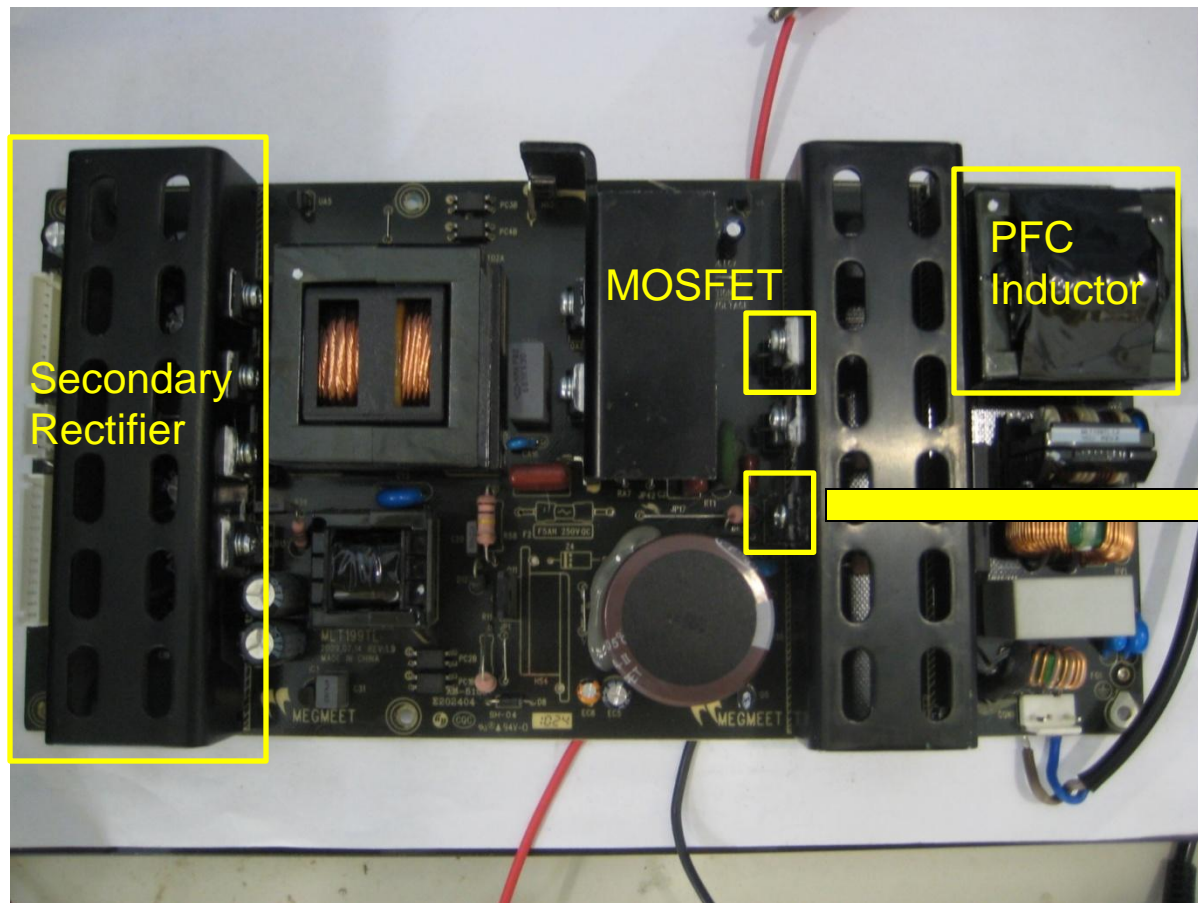
Leakage Current(μA) Curve vs. Temperature



Competitive leakage current

Benchmark Evaluation

MEGMEET LCD TV SMPS Practical layout

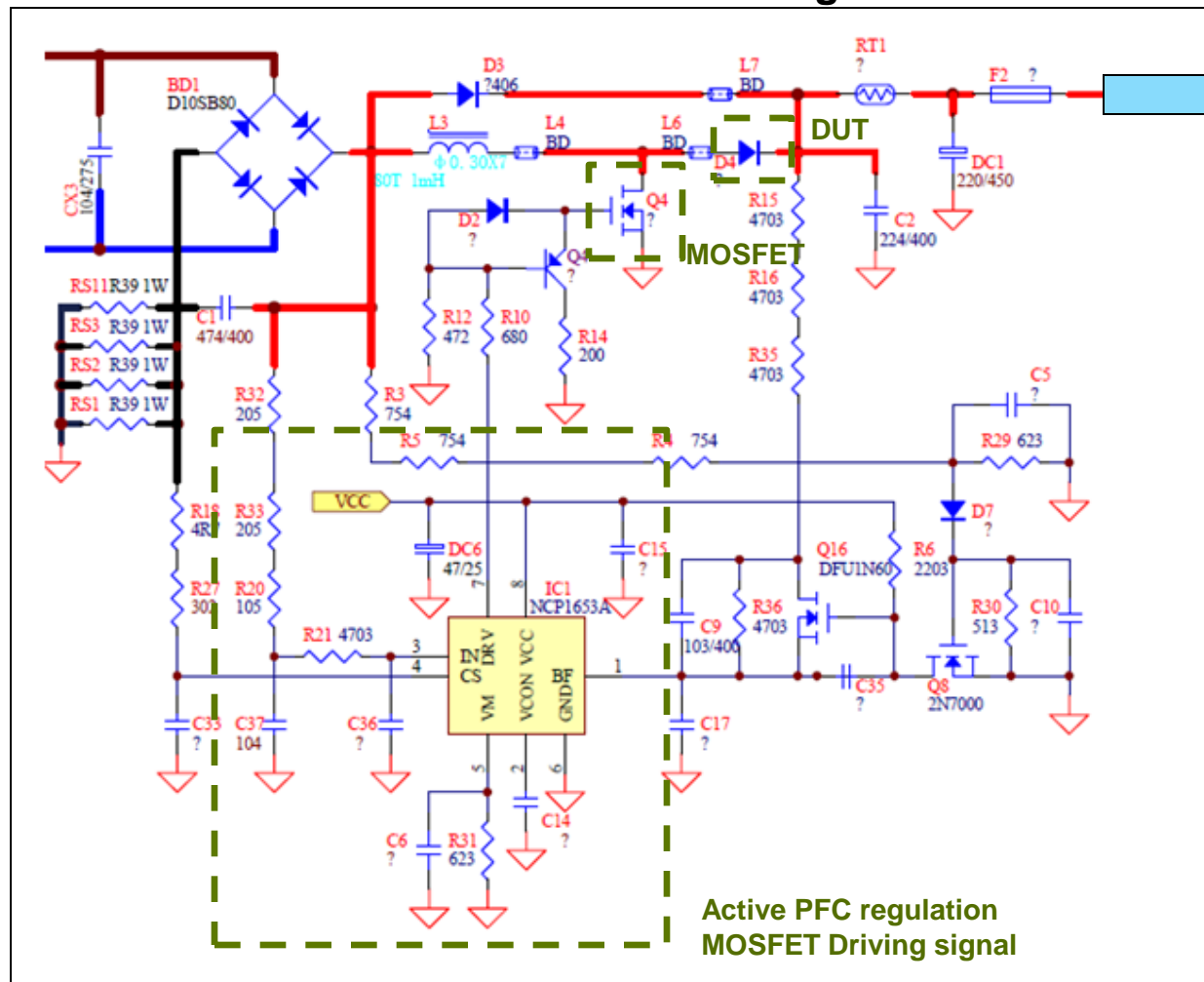


Device Under Test

MEGMEET MLT198L
This product has the output power set at 200 Watts.

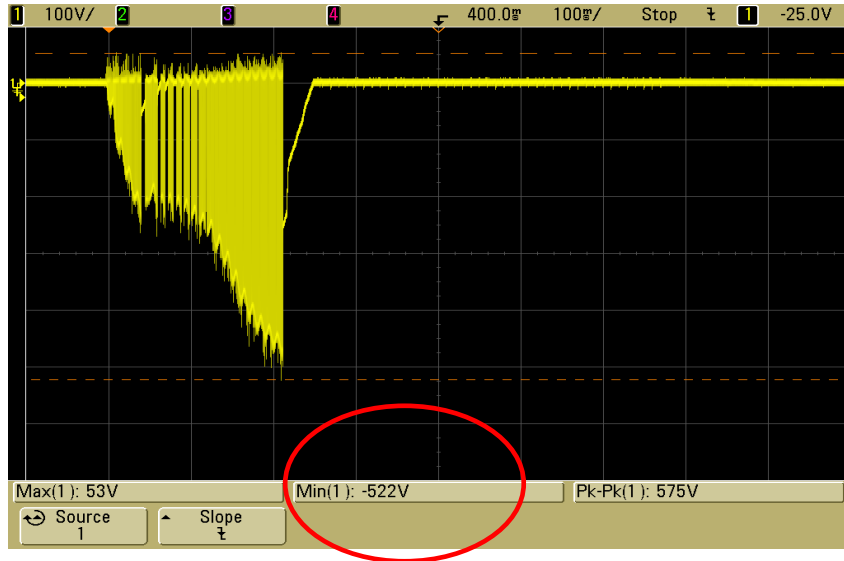
Benchmark Evaluation

MEGMEET LCD TV SMPS PFC Circuit Diagram

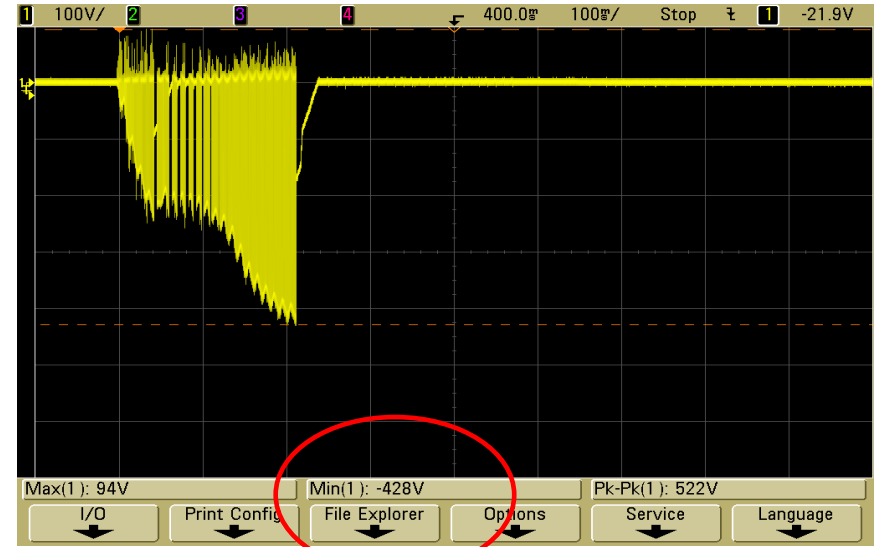


Connect to simulated electrical load

Reduced Peak Reverse Bias At Device Switch-On



DCM diode



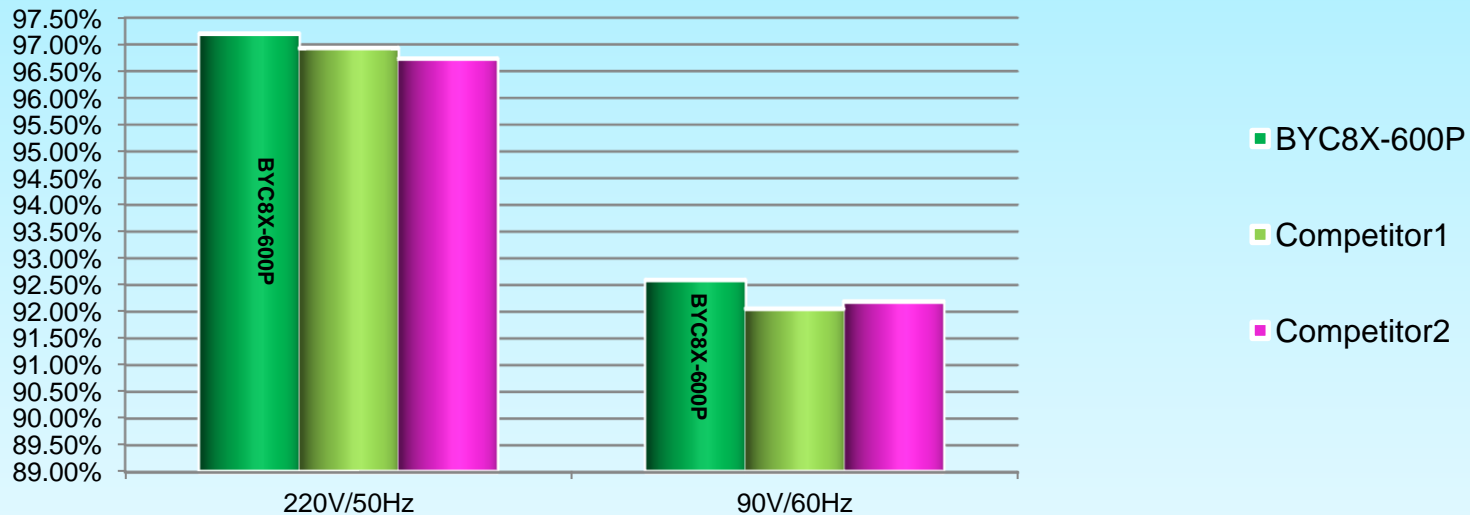
CCM diode

BYC8X-600P

A CCM diode has faster T_{rr} and achieves a lower peak reverse bias at switch-on than a DCM (slower T_{rr}) diode.

Superior Power Efficiency Performance

Power Efficiency vs. Input Voltage

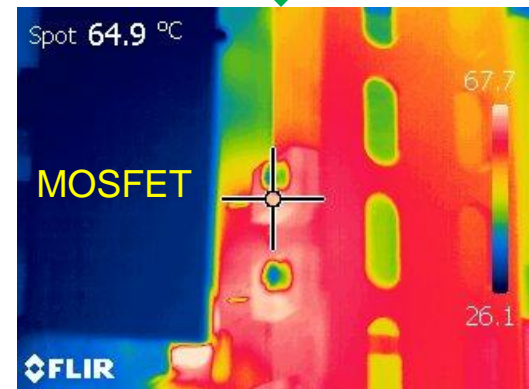
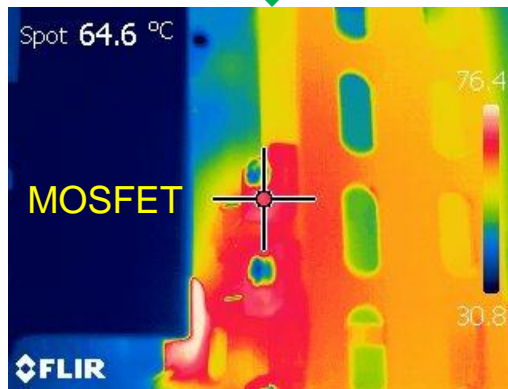
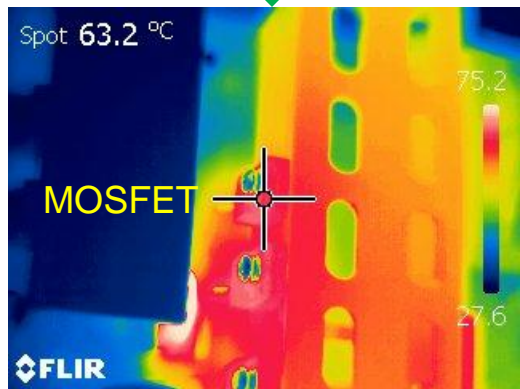
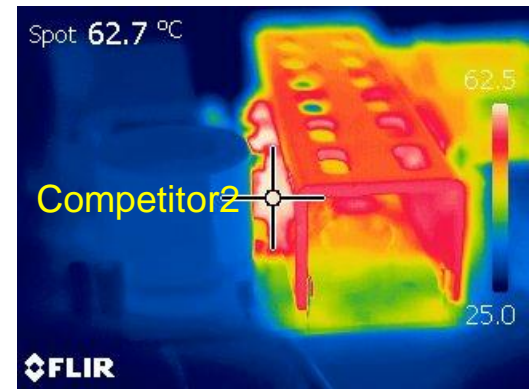
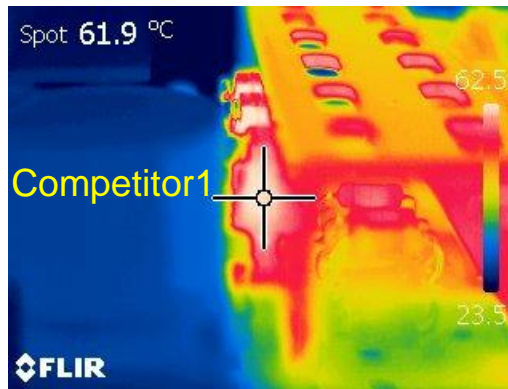
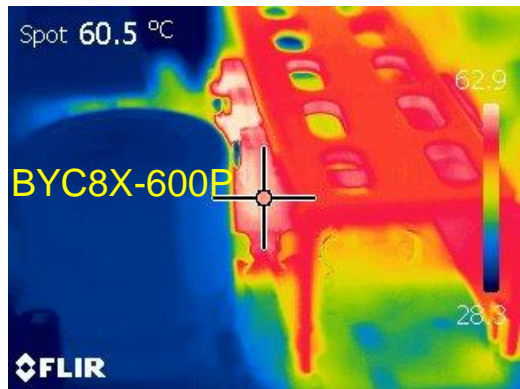


Max Output Load: 200W / 400V; Input voltages : 220V / 50Hz / 1A; 90V / 60Hz / 2.2A

For PFC: BYC8-600P & BYC8X-600P always achieve better power efficiency performance

Competitive Thermal Performance

Test condition: $V_{in}=90V_{ac}$, $f=60Hz$, Output power=200W.



Thermal performance of BYC8(X)-600P is similar compared with competitors, even slightly better due to very competitive V_F - t_{rr} trade-off correlation and R_{th} parameter.

Datasheet



BYC8-600P
Preliminary datasheet



BYC8X-600P
Preliminary datasheet

The background features a large yellow parallelogram tilted at an angle, set against a dark green background. A solid blue vertical bar is positioned on the left side of the image.

THANK YOU